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FQB30N06L / FQI30N06L 60V LOGIC N-Channel MOSFET

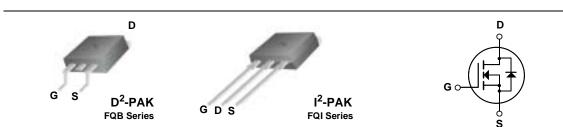
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as automotive, DC/ DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- 32A, 60V, R_{DS(on)} = 0.035Ω @V_{GS} = 10 V
- Low gate charge (typical 15 nC)
- Low Crss (typical 50 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating
- RoHS Compliant



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQB30N06L / FQI30N06L	Units
V _{DSS}	Drain-Source Voltage		60	V
ID	Drain Current - Continuous ($T_C = 25^{\circ}C$)		32	А
	- Continuous (T _C = 100°C)		22.6	А
I _{DM}	Drain Current - Pulsed	(Note 1)	128	А
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	350	mJ
I _{AR}	Avalanche Current	(Note 1)	32	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	7.9	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.75	W
	Power Dissipation $(T_C = 25^{\circ}C)$		79	W
	- Derate above 25°C		0.53	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.90	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

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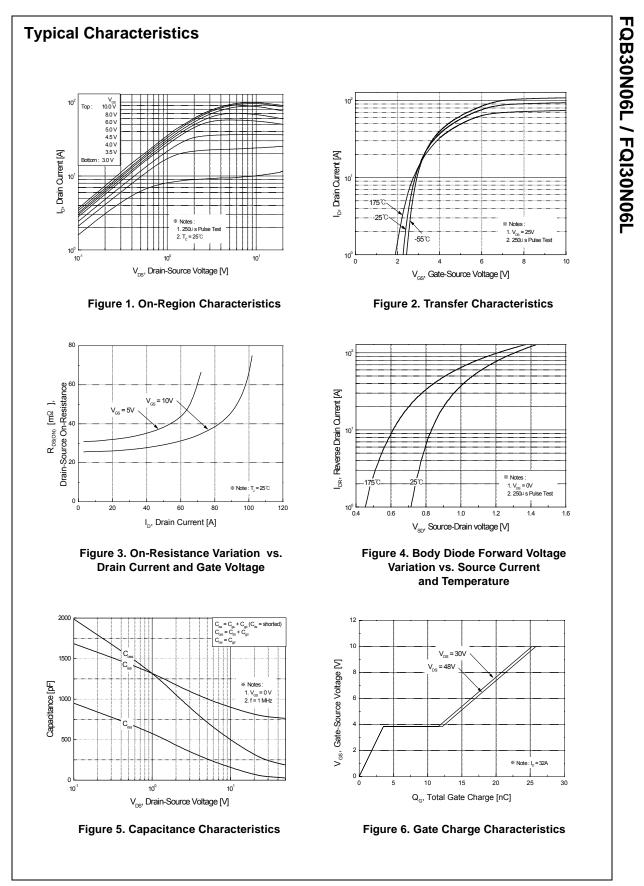
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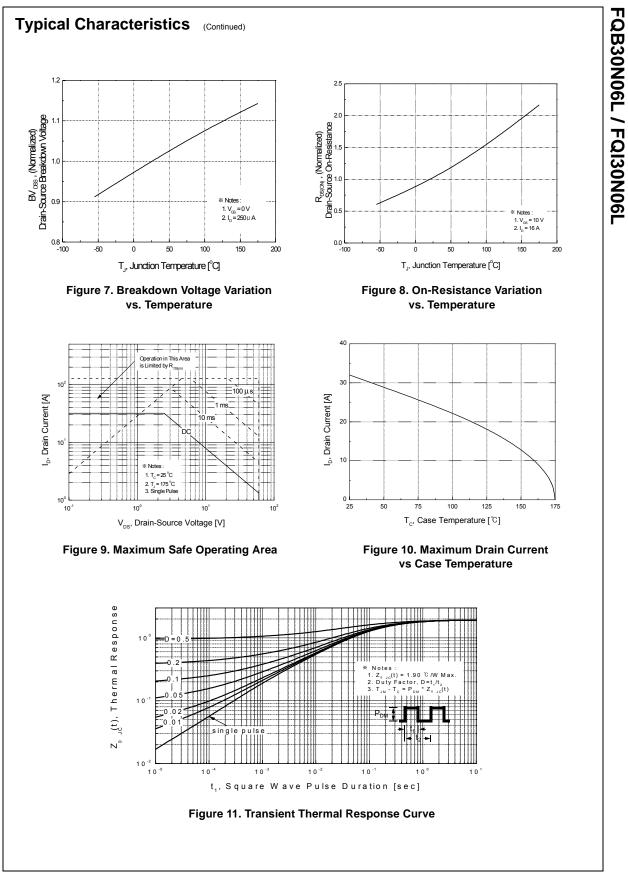
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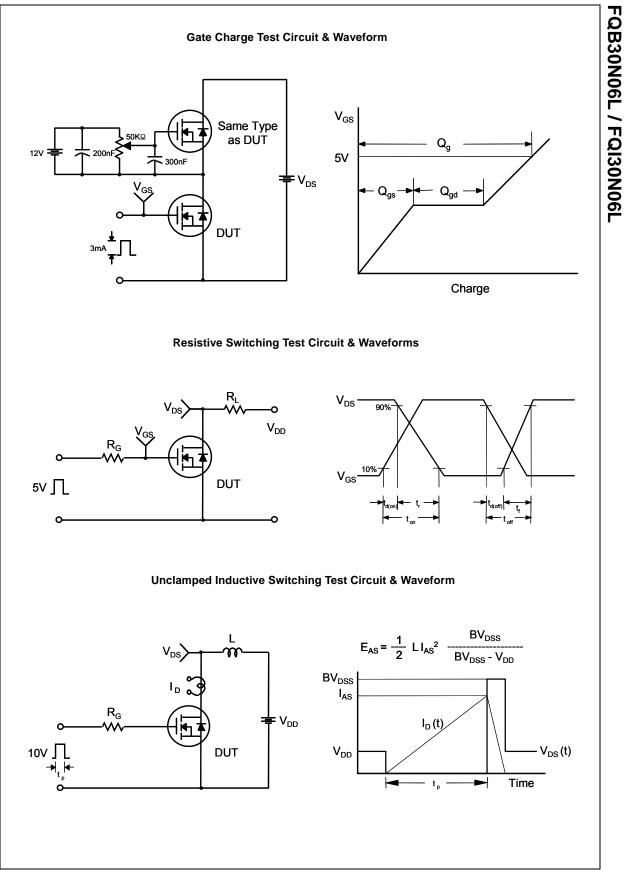
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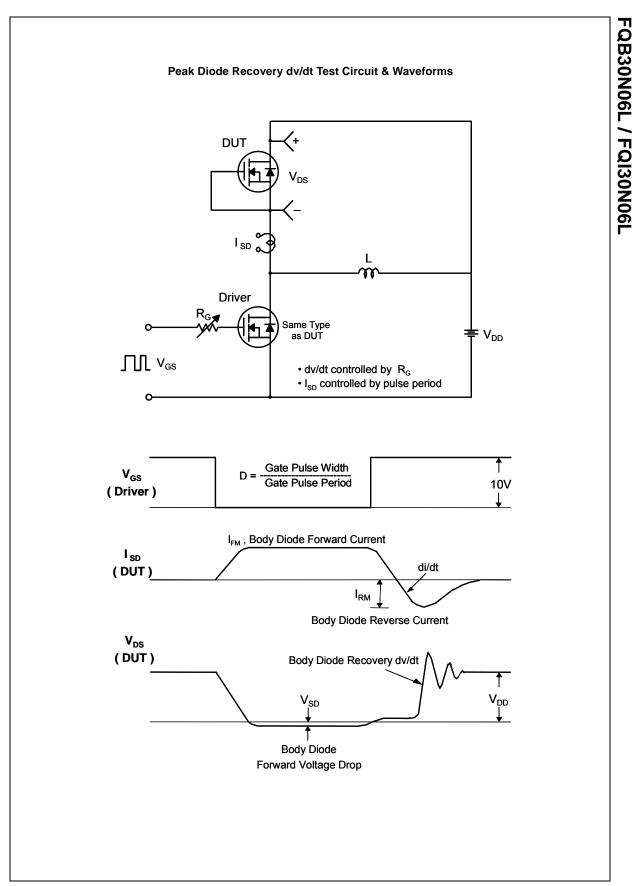
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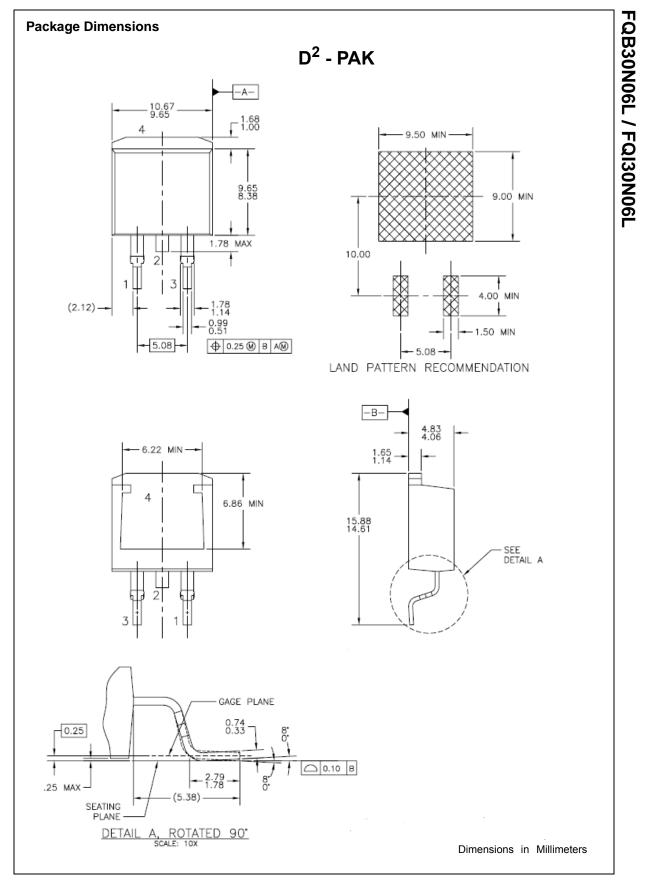
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V			1	μA
		$V_{\rm DS} = 48 \text{ V}, \text{ T}_{\rm C} = 150^{\circ}\text{C}$			10	μA
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
			1	I.		
	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$ $V_{GS} = 5 \text{ V}, I_D = 16 \text{ A}$		0.027 0.035	0.035 0.045	Ω
7=0	Forward Transconductance			24		S
9fs	i orward transconductance	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 16 \text{ A}$ (Note 4)		24		3
Dynami	ic Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		800	1040	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		270	350	pF
C _{rss}	Reverse Transfer Capacitance	-		50	65	pF
Switchi	ing Characteristics	V = 20 V L = 16 A		15	40	ns
r	Turn-On Rise Time	V _{DD} = 30 V, I _D = 16 A, R _G = 25 Ω		210	430	ns
t _{d(off)}	Turn-Off Delay Time	1.0 - 23 22		60	130	ns
ł	Turn-Off Fall Time	(Note 4, 5)		110	230	ns
Q _g	Total Gate Charge	V _{DS} = 48 V, I _D = 32 A,		15	20	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		3.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		8.5		nC
Drain-9	Source Diode Characteristics a	nd Maximum Ratings				
s	Maximum Continuous Drain-Source Dic	•			32	А
SM	Maximum Pulsed Drain-Source Diode F				128	A
V _{SD}		$V_{GS} = 0 V, I_S = 32 A$			1.5	V
rr	Reverse Recovery Time	V _{GS} = 0 V, I _S = 32 A,		60		ns
Q _{rr}	Reverse Recovery Charge	$dI_{\rm F}$ / dt = 100 A/µs (Note 4)		90		nC
$\begin{array}{l} L = 400 \mu H, \mbox{ I} \\ I_{SD} \leq 32 A, \mbox{ Pulse Test} \end{array}$	tating : Pulse width limited by maximum junction temper $I_{AS} = 32A$, $V_{DD} = 25V$, $R_G = 25 \Omega$, Starting $T_J = 25^{\circ}C$ di/dt $\leq 300A/us$, $V_{DD} = 8V_{DSS}$ Starting $T_J = 25^{\circ}C$ Pulse width ≤ 300 us, Duty cycle $\leq 2\%$ ndependent of operating temperature	rature				

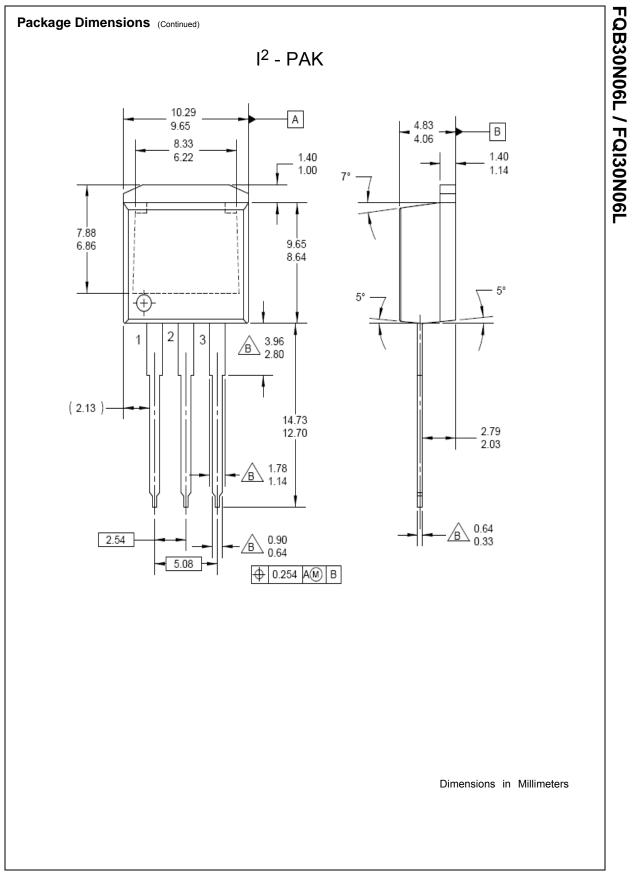














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